

## Features

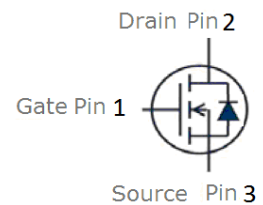
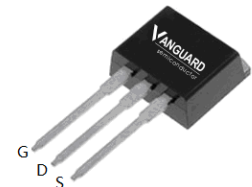
- N-Channel, 10V Logic Level Control
- Enhancement mode
- Very low on-resistance
- Fast Switching
- 100% Avalanche Tested
- Pb-free lead plating; RoHS compliant



Part ID	Package Type	Marking	Tape and reel information
VSI003N06HS	TO-251-L	003N06H	75pcs/Tube

$V_{DS}$	60	V
$R_{DS(on),TYP}@ V_{GS}=10V$	4.0	m $\Omega$
$I_D$	140	A

### TO-251-L



## Maximum ratings, at $T_j=25\text{ }^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	60	V
$I_S$	Diode continuous forward current	$T_C=25^\circ\text{C}$ 140	A
$I_D$	Continuous drain current@VGS=10V	$T_C=25^\circ\text{C}$ 140	A
		$T_C=100^\circ\text{C}$ 90	A
$I_{DM}$	Pulse drain current tested ①	$T_C=25^\circ\text{C}$ 560	A
IAS	Avalanche current	L=0.5mH 48	A
EAS	Avalanche energy, single pulsed ②	100	mJ
$P_D$	Maximum power dissipation	$T_C=25^\circ\text{C}$ 175	W
VGS	Gate-Source voltage	$\pm 20$	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	$^\circ\text{C}$

## Thermal Characteristics

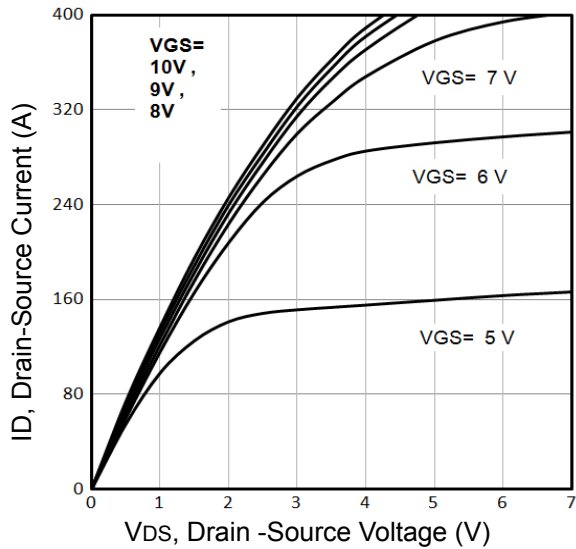
Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.85	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	48	$^\circ\text{C/W}$

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	60	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current(T <sub>c</sub> =25°C)	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T <sub>c</sub> =125°C)	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	--	--	100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	2.0	3.0	4.0	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =45A	--	4.0	4.8	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, f=1MHz	--	5220	--	pF
C <sub>oss</sub>	Output Capacitance		--	570	--	pF
C <sub>riss</sub>	Reverse Transfer Capacitance		--	380	--	pF
R <sub>g</sub>	Gate Resistance	f=1MHz	--	1.8	--	Ω
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =30V,I <sub>D</sub> =20A, V <sub>GS</sub> =10V	--	124	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	11	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	14	--	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =30V, I <sub>D</sub> =10A, R <sub>G</sub> =3.5Ω, V <sub>GS</sub> =10V	--	26	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	23	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	45	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	12	--	nS
<b>Source- Drain Diode Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
V <sub>SD</sub>	Forward on voltage	I <sub>SD</sub> =35A,V <sub>GS</sub> =0V	--	0.83	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>j</sub> =25°C,I <sub>sd</sub> =20A, di/dt=500A/μs	--	32	--	nS
Q <sub>rr</sub>	Reverse Recovery Charge		--	141	--	nC

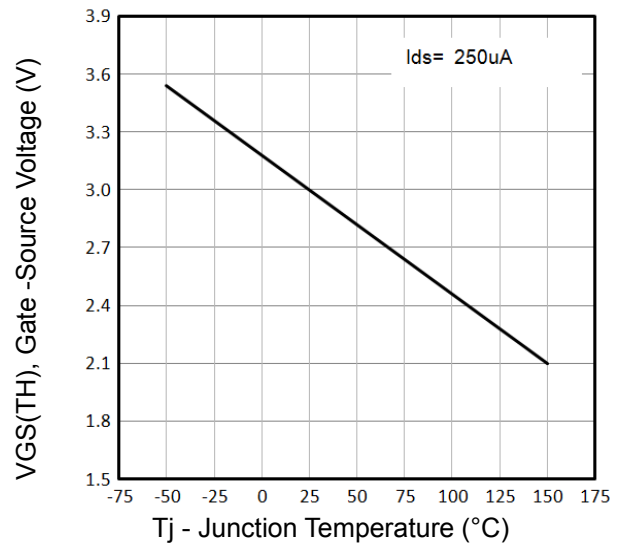
**NOTE:**

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T<sub>jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.5mH,R<sub>G</sub> = 25Ω, I<sub>AS</sub> = 20A, V<sub>GS</sub> = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

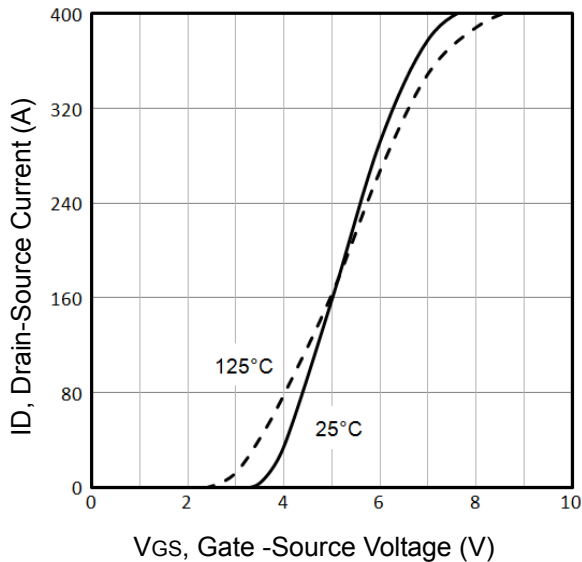
**Typical Characteristics**



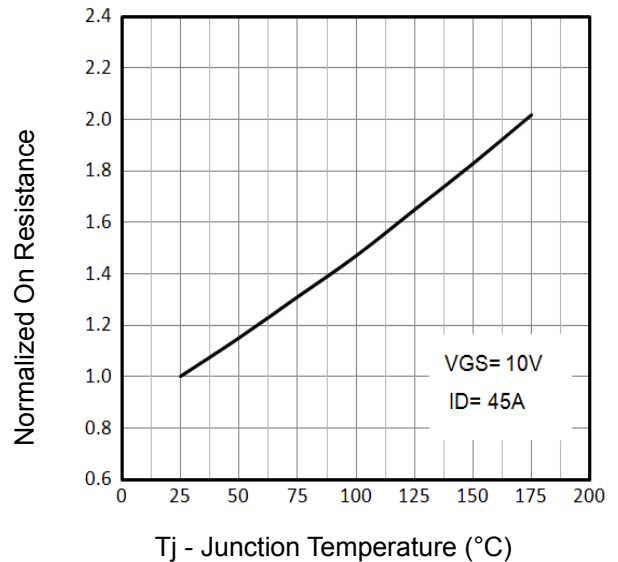
**Fig1.** Typical Output Characteristics



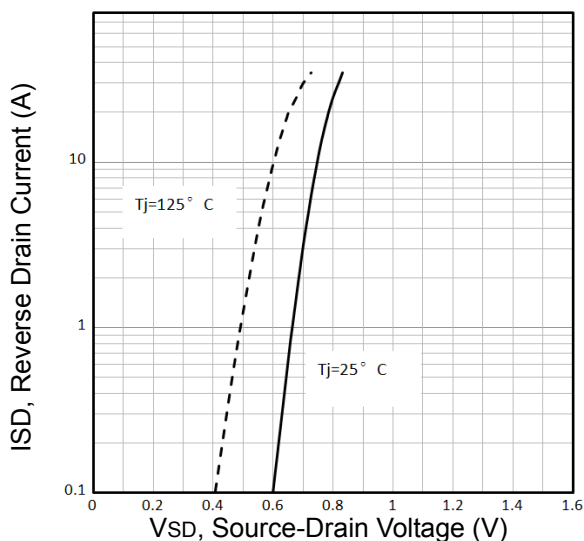
**Fig2.**  $V_{GS(TH)}$  Gate-Source Voltage Vs.  $T_j$



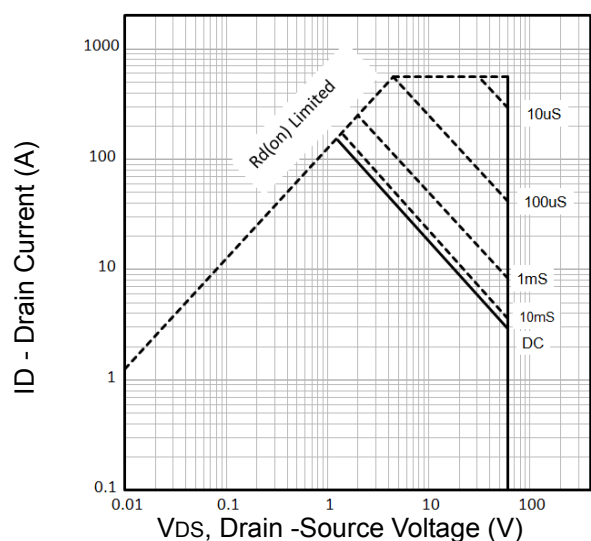
**Fig3.** Typical Transfer Characteristics



**Fig4.** Normalized On-Resistance Vs.  $T_j$

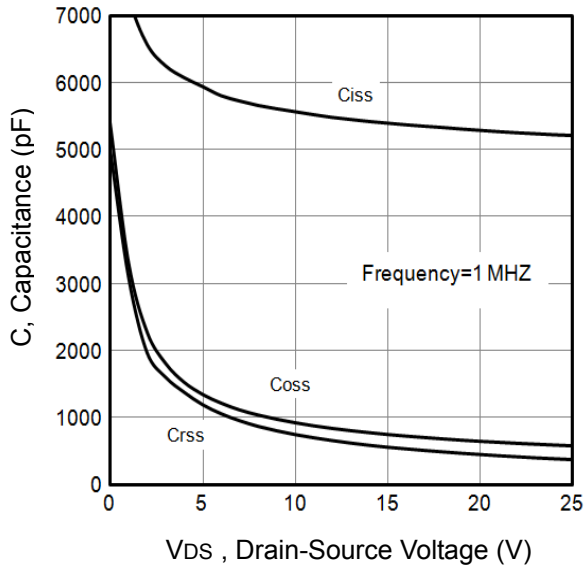


**Fig5.** Typical Source-Drain Diode Forward Voltage

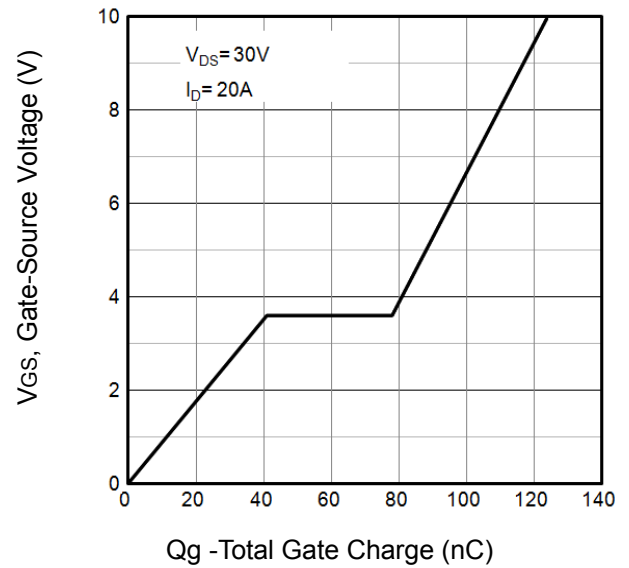


**Fig6.** Maximum Safe Operating Area

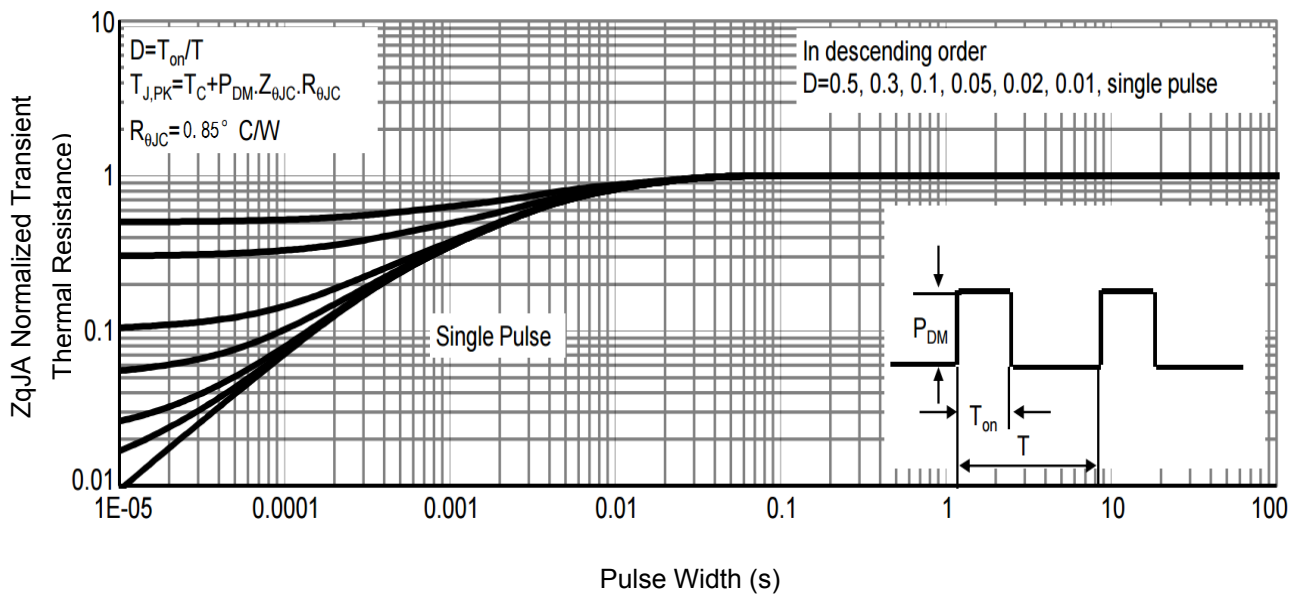
**Typical Characteristics**



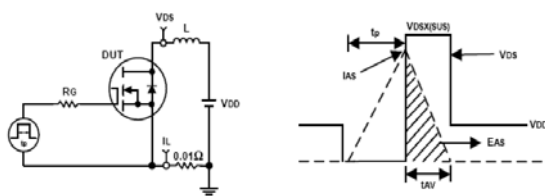
**Fig7.** Typical Capacitance Vs.Drain-Source Voltage



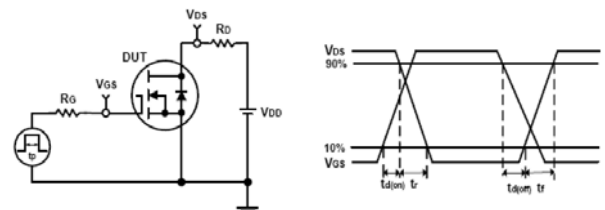
**Fig8.** Typical Gate Charge Vs.Gate-Source



**Fig9 .** Normalized Maximum Transient Thermal Impedance

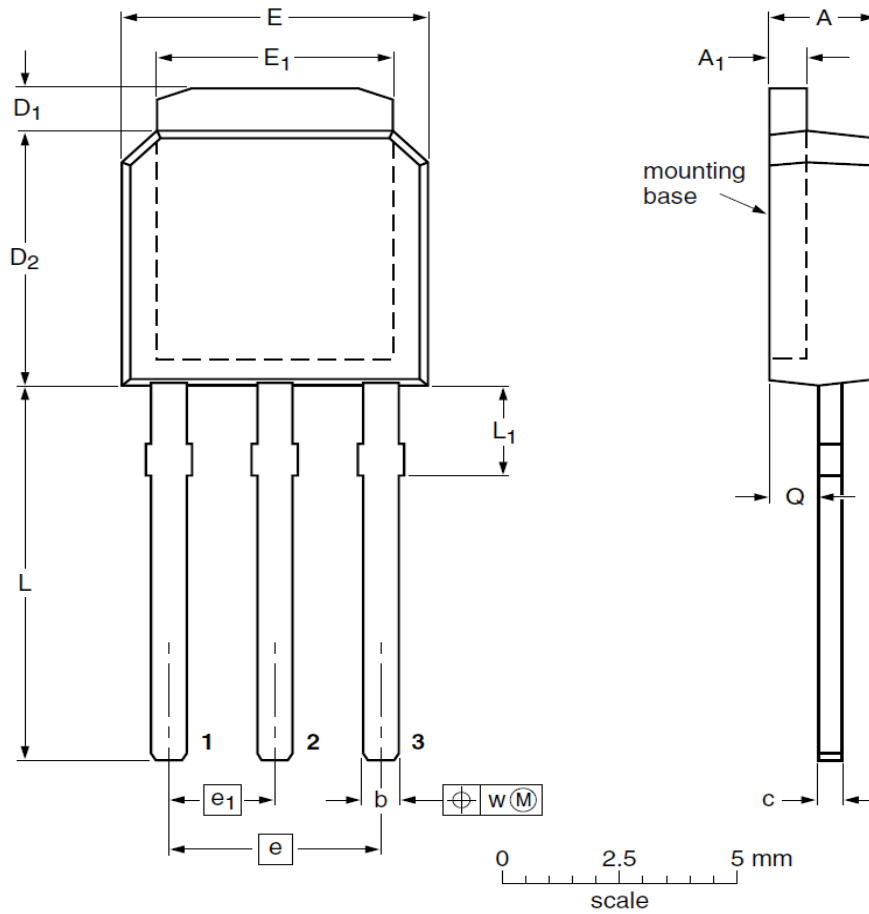


**Fig10.** Unclamped Inductive Test Circuit and waveforms



**Fig11.** Switching Time Test Circuit and waveforms

## TO-251-L Package Outline



**DIMENSIONS ( unit : mm )**

Label	Min	Typ	Max	Label	Min	Typ	Max
A	2.22	2.30	2.38	A <sub>1</sub>	0.46	0.55	0.93
b	0.71	0.78	0.89	c	0.46	0.51	0.56
D <sub>1</sub>	0.96	1.02	1.10	D <sub>2</sub>	5.98	6.05	6.22
E	6.47	6.60	6.73	E <sub>1</sub>	5.20	5.33	5.55
e	--	4.57	--	e <sub>1</sub>	--	2.28	--
L	9.20	9.38	9.60	L <sub>1</sub>	--	2.70	--
Q	1.00	1.05	1.10	w	--	0.30	--

## Customer Service

**Sales and Service:**

[sales@vgsemi.com](mailto:sales@vgsemi.com)

**Vanguard Semiconductor CO., LTD**

**TEL:** (86-755) -26902410

**FAX:** (86-755) -26907027

**WEB:** [www.vgsemi.com](http://www.vgsemi.com)